



Material Content Data Sheet



Halogen-Free

Sales Product Name	ILD6070	Issued	03. May 2021
MA#	MA001040756		
Package	PG-DSO-8-27	Weight*	84.09 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	2.018	2.40	2.40	24001	24001
leadframe	inorganic material	phosphorus	7723-14-0	0.009	0.01		108	
	non noble metal	zinc	7440-66-6	0.036	0.04		433	
	non noble metal	iron	7439-89-6	0.728	0.87		8654	
	non noble metal	copper	7440-50-8	29.548	35.14	36.06	351391	360586
wire	noble metal	gold	7440-57-5	0.202	0.24	0.24	2398	2398
encapsulation	organic material	carbon black	1333-86-4	0.099	0.12		1176	
	plastics	epoxy resin	-	4.547	5.41		54074	
	inorganic material	silicondioxide	60676-86-0	44.778	53.24	58.77	532514	587764
leadfinish	non noble metal	tin	7440-31-5	0.695	0.83	0.83	8267	8267
plating	noble metal	silver	7440-22-4	0.725	0.86	0.86	8616	8616
glue	plastics	epoxy resin	-	0.176	0.21		2092	
	noble metal	silver	7440-22-4	0.528	0.63	0.84	6276	8368
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption.

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